# 2SD0968, 2SD0968A (2SD968, 2SD968A)

## Silicon NPN epitaxial planer type

For low-frequency driver amplification
Complementary to 2SB0789 (2SB789) and 2SB0789A (2SB789A)

### Features

- High collector to emitter voltage V<sub>CEO</sub>.
- Large collector power dissipation P<sub>C</sub>.
- Mini Power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

### Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Ratings	Unit	
Collector to	2SD0968	V	100	v	
base voltage	2SD0968A	$V_{CBO}$	120		
Collector to	2SD0968	V	100	V	
emitter voltage	2SD0968A	$V_{CEO}$	120		
Emitter to base voltage		$V_{\rm EBO}$	5	V	
Peak collector current		$I_{CP}$	1	A NO	
Collector current		$I_{\rm C}$	0.5	A	
Collector power dissipation		$P_C^*$	1	w. V	
Junction temperature		$T_{j}$	150	°C	
Storage temperature		$T_{stg}$	<b>−55 ~ +150</b>	∂°C .⊘	

<sup>\*</sup> Printed circuit board: Copper foil area of 1cm² or more, and the board thickness of 1.7mm for the collector portion

# Unit: mm 4.5±0.1 1.6±0.2 1.5±0.1 0.4±0.08 1.5±0.1 1

Marking symbol : W(2SD0968) V(2SD0968A)

### Electrical Characteristics (Ta=25°C)

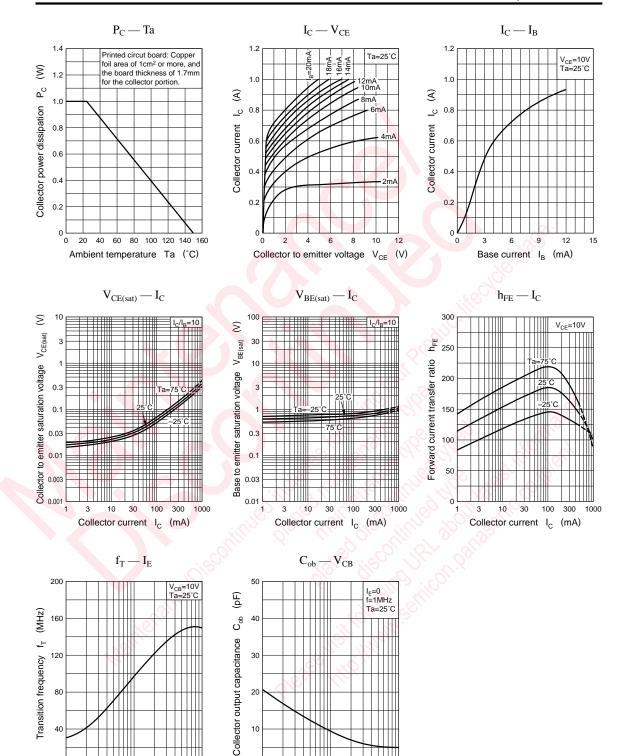
Parameter		Symbol	Conditions	min	typ	max	Unit
Collector to emitter	2SD0968	- V <sub>CEO</sub>	$I_C = 100 \mu A, I_B = 0$	100			v
voltage	2SD0968A			120			V
Emitter to base voltage		$V_{\rm EBO}$	$I_{\rm E} = 10 \mu A, I_{\rm C} = 0$	5			V
Forward current transfer ratio		h <sub>FE1</sub> *1	$V_{CE} = 10V, I_C = 150 \text{mA}^{*2}$	90		220	
		h <sub>FE2</sub>	$V_{CE} = 5V, I_{C} = 500 \text{mA}^{*2}$	50	100		
Collector to emitter saturation voltage		V <sub>CE(sat)</sub>	$I_C = 500 \text{mA}, I_B = 50 \text{mA}^{*2}$		0.2	0.6	V
Base to emitter saturation voltage $V_{BE(sat)}$		V <sub>BE(sat)</sub>	$I_C = 500 \text{mA}, I_B = 50 \text{mA}^{*2}$		0.85	1.2	V
Transition frequency $f_T$		$f_T$	$V_{CB} = 10V, I_E = -50mA, f = 200MHz$		120		MHz
Collector output capacitance C <sub>ob</sub>		Cob	$V_{CB} = 10V, I_E = 0, f = 1MHz$		11	20	pF

<sup>\*1</sup>h<sub>FE1</sub> Rank classification

\*2 Pulse measurement

Note.) The Part numbers in the Parenthesis show conventional part number.

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10

-3

-10

Emitter current I<sub>E</sub> (mA)

-30

-100

3

30

100

10

Collector to base voltage  $V_{CB}$  (V)

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